Vishay Semiconductors

Ultralow V_F Ultrafast Rectifier, 6 A FRED Pt[®]



6 A

600 V

0.87 V

59 ns

175 °C

DPAK (TO-252AA)

Single

PRIMARY CHARACTERISTICS

I_{F(AV)}

 V_{R}

V_F at I_F

trr (typ.)

T_{.1} max.

Package

Circuit configuration

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FΕ	AT	'UR	ES

- Ultrafast recovery time, extremely low V_F and soft recovery
- 175 °C maximum operating junction temperature
- For PFC DCM operation
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Peak repetitive reverse voltage	V _{RRM}		600	V						
Average rectified forward current	I _{F(AV)}	T _C = 156 °C	6							
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	80	А						
Peak repetitive forward current	I _{FM}	$T_{C} = 156 \ ^{\circ}C, f = 20 \ \text{kHz}, d = 50 \ \%$	12							
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	600	-	-					
	VF	I _F = 6 A	-	0.99	1.25	5 V				
Forward voltage	۷F	I _F = 6 A, T _J = 150 °C	-	0.87	1.05					
Reverse leakage current		$V_{R} = V_{R}$ rated	-	-	- 5					
	I _R	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	125	μΑ				
Junction capacitance	CT	V _R = 600 V	-	3.5	-	pF				
Series inductance	Ls	Measured lead to lead 5 mm from package body	-	8	-	nH				

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(e3) RoHS

COMPLIANT



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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1 \text{ A}, dI_F/dt = 10$	00 A/µs, V _R = 30 V	-	59	70				
	+	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	75	-				
	t _{rr}	T _J = 25 °C		-	154	-	A			
		T _J = 125 °C	I _F = 6A dI _F /dt = 200 A/μs V _B = 390 V	-	215	-				
Poak rocovary ourrant	I _{RRM}	T _J = 25 °C		-	13.3	-				
Peak recovery current		T _J = 125 °C		-	15.4	-				
Reverse recovery charge	Q _{rr}	T _J = 25 °C		-	1055	-	nC			
		T _J = 125 °C		-	1600	-				

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C			
Thermal resistance, junction to case per leg	R _{thJC}		-	-	3	°C/W			
Approximate weight				0.3		g			
Approximate weight				0.01		oz.			
Marking device		Case style DPAK (TO-252AA)	6EWL06FN						



VS-6EWL06FN-M3

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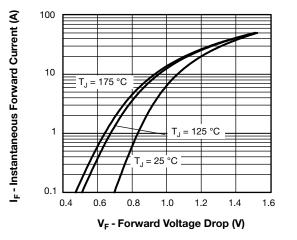


Fig. 1 - Typical Forward Voltage Drop Characteristics

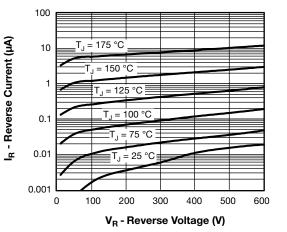
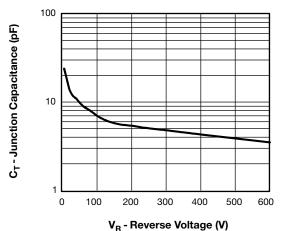
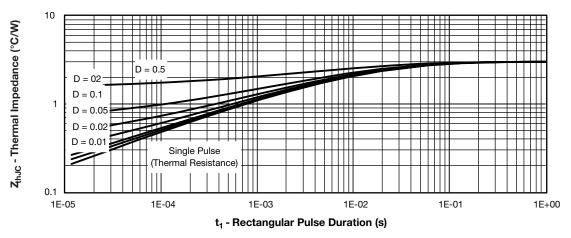


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



VR - Neverse voltage (v)

Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage





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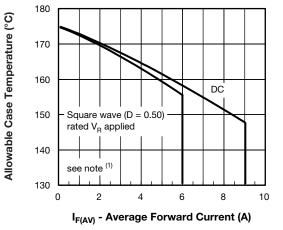


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

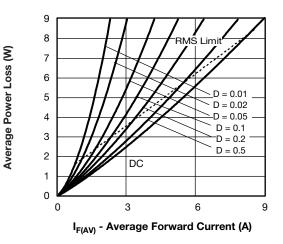
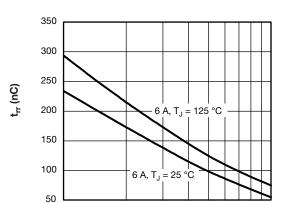


Fig. 6 - Forward Power Loss Characteristics

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); Pd_{BEV} = inverse power loss = $V_{B1} \times I_{B} (1 - D)$; I_{B} at V_{B1} = rated V_{B}



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1000

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100

Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

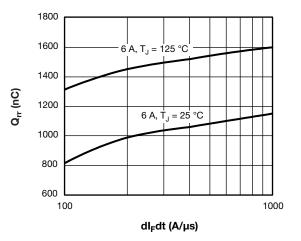


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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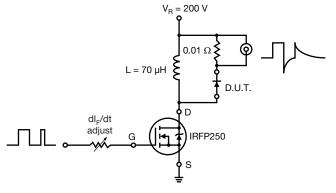


Fig. 9 - Reverse Recovery Parameter Test Circuit

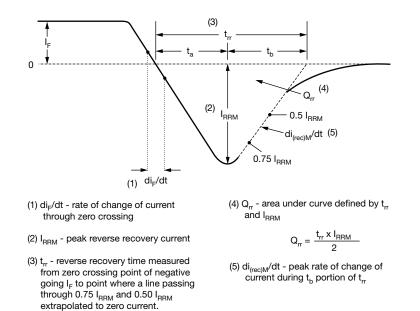


Fig. 10 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

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SHAY

Device code	vs-	6	Е	w	L	06	FN	TRL	-M3
				<u> </u>					
	1	2	3	4	5	6	7	8	9
	1	- Visl	nay Sen	nicondu	ctors pro	oduct			
	2	- Cur	rent rati	ng (6 =	6 A)				
	3	- Circ	uit conf	iguratio	า:				
		E =	single o	liode					
	4	- Pac	kage id	entifier:					
	_		D-PAK	-					
			-	fast rec					
	6		-	ng (06 =	= 600 V))			
	느		= TO-25						
	8		one = tu						
			-	e and ree					
			-	be and re	-		-		
			-	be and r		nt orient	ed)		
	9	- Env	rironmer	ntal digit	:				
		-M3	s = halog	gen-free	, RoHS	-complia	ant and	termina	tions le

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-6EWL06FN-M3	75	3000	Antistatic plastic tube							
VS-6EWL06FNTR-M3	2000	2000	13" diameter reel							
VS-6EWL06FNTRL-M3	3000	3000	13" diameter reel							
VS-6EWL06FNTRR-M3	3000	3000	13" diameter reel							

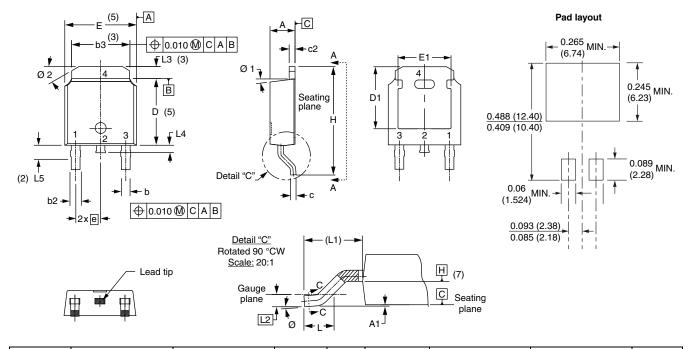
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95627						
Part marking information	www.vishay.com/doc?95176						
SPICE model	www.vishay.com/doc?95218						





D-PAK (TO-252AA) "M"

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	S SYMBOL		MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	2.18	2.39	0.086	0.094			е	2.29	BSC	0.090	BSC	
A1	-	0.13	-	0.005			Н	9.40	10.41	0.370	0.410	
b	0.64	0.89	0.025	0.035			L	1.40	1.78	0.055	0.070	
b2	0.76	1.14	0.030	0.045			L1	2.74	BSC	0.108	REF.	
b3	4.95	5.46	0.195	0.215	3		L2	0.51 BSC		0.020 BSC		
с	0.46	0.61	0.018	0.024			L3	0.89	1.27	0.035	0.050	3
c2	0.46	0.89	0.018	0.035			L4	-	1.02	-	0.040	
D	5.97	6.22	0.235	0.245	5		L5	1.14	1.52	0.045	0.060	2
D1	5.21	-	0.205	-	3		Ø	0°	10°	0°	10°	
E	6.35	6.73	0.250	0.265	5		Ø1	0°	15°	0°	15°	
E1	4.32	-	0.170	-	3		Ø2	25°	35°	25°	35°	

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Lead dimension uncontrolled in L5

⁽³⁾ Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁶⁾ Dimension b1 and c1 applied to base metal only

⁽⁷⁾ Datum A and B to be determined at datum plane H

⁽⁸⁾ Outline conforms to JEDEC[®] outline TO-252AA

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